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**BB179B** UHF variable capacitance diode Rev. 3 — 5 September 2011

**Product data sheet** 

## 1. Product profile

#### 1.1 General description

The BB179B is a variable capacitance diode, fabricated in planar technology and encapsulated in the SOD523 (SC-79) ultra small SMD plastic package. The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

#### **1.2 Features and benefits**

- Excellent linearity
- Excellent matching to 2 % DMA
- Ultra small SMD plastic package
- C<sub>d(28V)</sub>: 2.1 pF; C<sub>d(1V)</sub> to C<sub>d(28V)</sub> ratio: 9
- Low series resistance.

#### 1.3 Applications

- Electronic tuning in UHF television tuners
- Voltage Controlled Oscillators (VCO).

#### 2. Pinning information

Table 1.	Pinning		
Pin	Description	Simplified outline <sup>[1]</sup>	Symbol
1	cathode		
2	anode	1 2	-₩- sym008

[1] The marking bar indicates the cathode.

## 3. Ordering information

Table 2. Order	ing informati	ion	
Type number	Package		
	Name	Description	Version
BB179B	SC-79	plastic surface mounted package; 2 leads	SOD523



## 4. Marking

Table 3. Marking	
Type number	Marking code
BB179B	С

## 5. Limiting values

	Limiting values ace with the Absolute Maximu	um Rating System (IEC 6	50134).		
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>R</sub>	reverse voltage		-	32	V
V <sub>RM</sub>	peak reverse voltage	in series with a 10 k $\Omega$ resistor	-	35	V
l <sub>F</sub>	forward current		-	20	mA
T <sub>stg</sub>	storage temperature		-55	+150	°C
Т <sub>ј</sub>	junction temperature		-55	+125	°C

## 6. Characteristics

#### Table 5. Characteristics

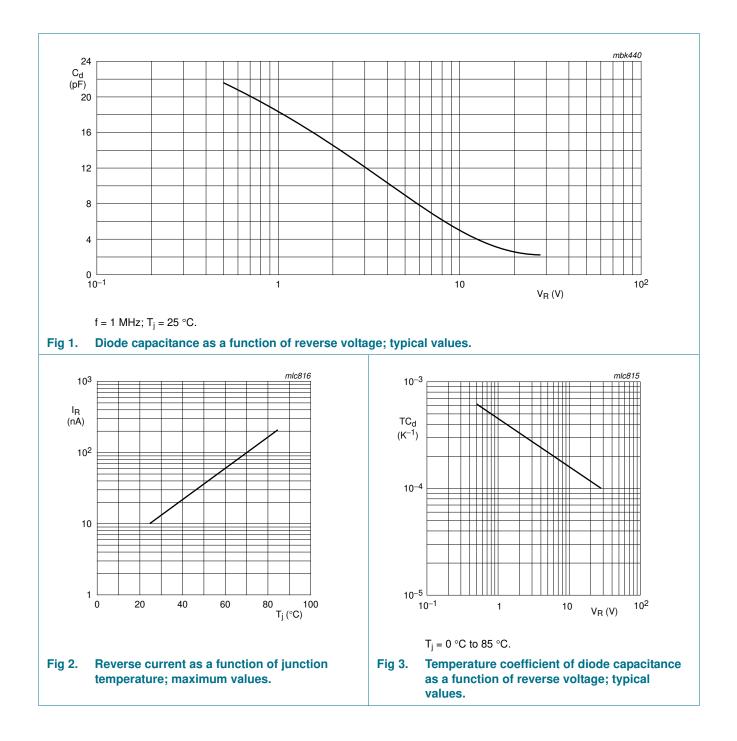
 $T_i = 25 \ ^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>R</sub> rev	reverse current	see Figure 2				
		V <sub>R</sub> = 30 V	-	-	10	nA
		$V_R = 30 \text{ V}; \text{ T}_j = 85 ^\circ\text{C}$	-	-	200	nA
r <sub>s</sub>	diode series resistance	f = 470 MHz	<u>[1]</u> _	0.6	0.75	Ω
C <sub>d</sub>	diode capacitance	f = 1 MHz; see <u>Figure 1</u> and <u>3</u>				
		V <sub>R</sub> = 1 V	18.22	-	20	pF
		V <sub>R</sub> = 28 V	1.9	2.1	2.25	pF
$\frac{C_{d(1V)}}{C_{d(2V)}}$	capacitance ratio	f = 1 MHz	-	1.27	-	
$\frac{C_{d(1V)}}{C_{d(28V)}}$	capacitance ratio	f = 1 MHz	8.45	9	10	
$\frac{C_{d(25V)}}{C_{d(28V)}}$	capacitance ratio	f = 1 MHz	-	1.05	-	
$\frac{\Delta C_d}{C_d}$	capacitance matching	$V_R = 1 V$ to 28 V; in a sequence of 10 diodes (gliding)	-	-	2	%

[1]  $V_R$  is the value at which  $C_d = 9 \text{ pF}$ 

#### **NXP Semiconductors**

## UHF variable capacitance diode



UHF variable capacitance diode

## 7. Package outline

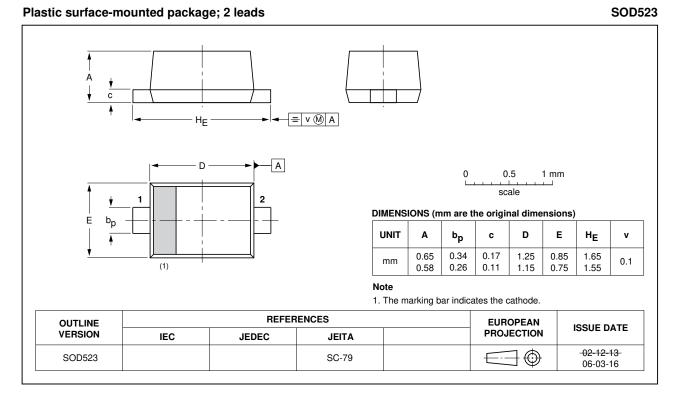


Fig 4. Package outline SOD523 (SC-79).

## 8. Revision history

Table 6. Revision h	history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BB179B v.3	20110905	Product data sheet	-	BB179B v.2
Modifications:		t of this data sheet has beer of NXP Semiconductors.	n redesigned to comply v	vith the new identity
	<ul> <li>Legal texts</li> </ul>	s have been adapted to the i	new company name whe	ere appropriate.
	<ul> <li>Package d</li> </ul>	outline drawings have been ι	updated to the latest vers	sion.
BB179B v.2 (9397 750 13833)	20041005	Product data sheet	-	BB179B v.1
BB179 v.1 (9397 750 02984)	19971113	Product specification	-	-

## 9. Legal information

#### 9.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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# **BB179B**

#### UHF variable capacitance diode

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## **BB179B**

## **11. Contents**

1	Product profile 1
1.1	General description 1
1.2	Features and benefits 1
1.3	Applications 1
2	Pinning information 1
3	Ordering information 1
4	Marking 2
5	Limiting values 2
6	Characteristics 2
7	Package outline 4
8	Revision history 5
9	Legal information 6
9.1	Data sheet status 6
9.2	Definitions6
9.3	Disclaimers 6
9.4	Trademarks 7
10	Contact information 7
11	Contents 8

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